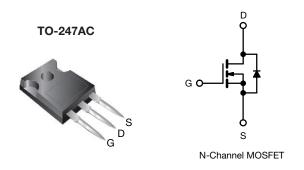


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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.0355			
Q _g max. (nC)	410				
Q _{gs} (nC)	38				
Q _{gd} (nC)	99				
Configuration	Single				

FEATURES

- · Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qa
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity lighting (HID)
 - Light emitting diodes (LEDs)
- · Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switching mode power supplies (SMPS)
- · Applications using the following topologies
- LLC
- Phase shifted bridge (ZVS)
- 3-level inverter
- AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and halogen-free	SiHG70N60AEF-GE3

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	600			
Gate-source voltage			V _{GS}	± 20	V		
Gate-source voltage AC (f > 1 Hz)				30			
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	I _D	60			
	VGS at 10 V	T _C = 100 °C		38	А		
Pulsed drain current ^a			I _{DM}	173			
Linear derating factor				3.3	W/°C		
Single pulse avalanche energy ^b			E _{AS}	E _{AS} 1019			
Maximum power dissipation			PD	417	W		
Operating junction and storage temperature range			T _J , T _{stg}	T _J , T _{stg} -55 to +150			
Drain-source voltage slope	T _J = 125 °C		dv/dt	70	V/ns		
Reverse diode dv/dt ^d			av/at	50	v/ns		
Soldering recommendations (peak temperature) ^c	For 10 s			300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 140$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_a = 25 \Omega$, $I_{AS} = 8.5$ A

c. 1.6 mm from case

d. $I_{SD} = 35 \text{ A}, \text{ di/dt} = 300 \text{ A/}\mu\text{s}, \text{V}_{DS} = 400 \text{ V}$

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COMPLIANT

HALOGEN FREE



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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 40			00 AN			
Maximum junction-to-case (drain)	R _{thJC}	- 0.3				°C/W		
		·						
SPECIFICATIONS (T _J = 25 °C, u	Inless otherwi	ise noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static	•				•			•
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.62	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 µA	2	-	4	V
Gate-source leakage	I _{GSS}	N N	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		₀ = 35 A	-	0.0355	0.041	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} :	= 30 V, I _D =	= 35 A	-	23	-	S
Dynamic	•				•			1
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	5348	-		
Output capacitance	C _{oss}	, ,	$V_{\rm GS} = 100 \text{ V},$ $V_{\rm DS} = 100 \text{ V},$		-	238	-	1
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	7	-	pF	
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	159	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	810	-		
Total gate charge	Qq				-	205	410	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 35 A, V _{DS} = 4		-	38	-	nC
Gate-drain charge	Q _{gd}				-	99	-	
Turn-on delay time	t _{d(on)}				-	45	90	
Rise time	t _r	V _{DD} = 480 V, I _D = 35 A,		-	104	208	1	
Turn-off delay time	t _{d(off)}		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	219	438	ns
Fall time	t _f				-	113	226	
Gate input resistance	R _g	f = 1 MHz, open drain		0.5	1.0	2.0	Ω	
Drain-Source Body Diode Characteristic	cs	·				•		
Continuous source-drain diode current	١ _S	MOSFET sym showing the	MOSFET symbol showing the		-	-	60	_
Pulsed diode forward current	I _{SM}	p - n junction diode		-	-	173	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 35 A, V _{GS} = 0 V		-	0.9	1.2	V	
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 35 \text{ A},$ $di/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 400 \text{ V}$		-	184	368	ns	
Reverse recovery charge	Q _{rr}			-	1.6	3.2	μC	
Reverse recovery current	I _{RRM}			-	16	-	A	
·····	1 1 1 1 1 1			L	1 -		L	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

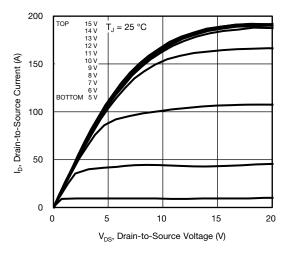
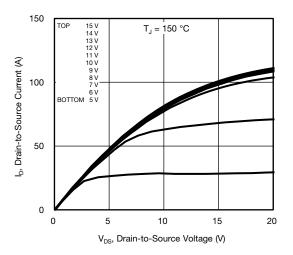
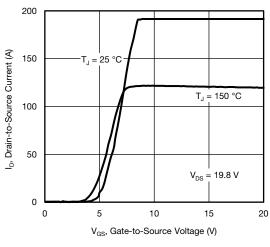


Fig. 1 - Typical Output Characteristics









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= 35 A $R_{\text{DS}(\text{on})},$ Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 10 0.5 0 -60 -40 -20 0 20 40 60 80 100 120 140 160 T₁, Junction Temperature (°C)

3.0

Fig. 4 - Normalized On-Resistance vs. Temperature

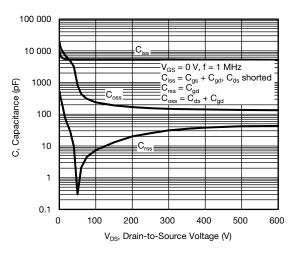


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

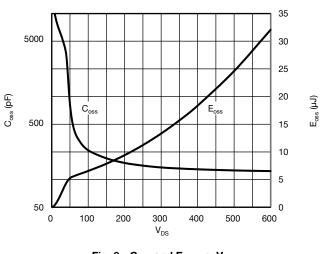


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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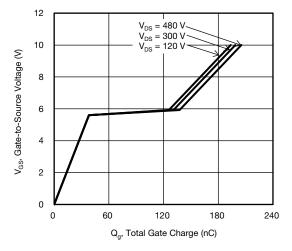


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

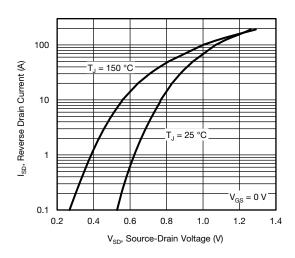


Fig. 8 - Typical Source-Drain Diode Forward Voltage

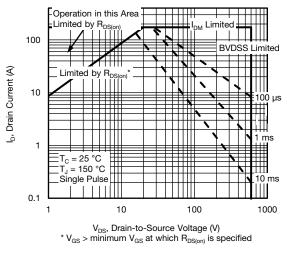


Fig. 9 - Maximum Safe Operating Area

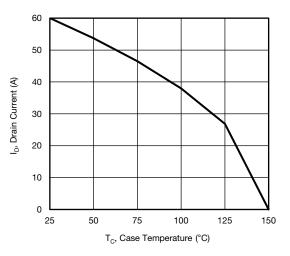


Fig. 10 - Maximum Drain Current vs. Case Temperature

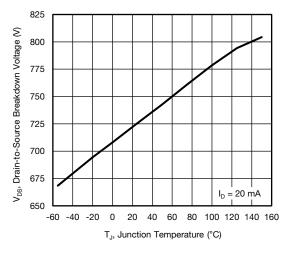


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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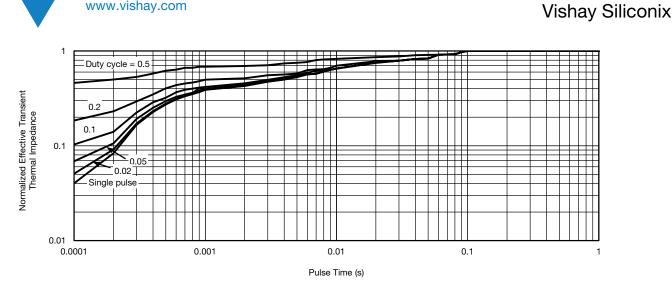
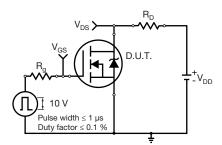


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case



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Fig. 13 - Switching Time Test Circuit

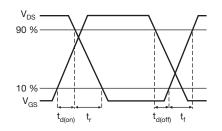


Fig. 14 - Switching Time Waveforms

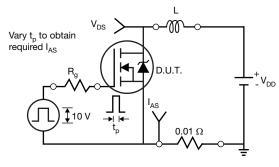
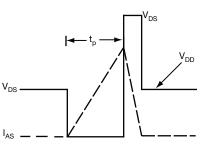


Fig. 15 - Unclamped Inductive Test Circuit



SiHG70N60AEF

Fig. 16 - Unclamped Inductive Waveforms

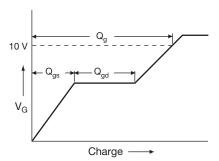


Fig. 17 - Basic Gate Charge Waveform

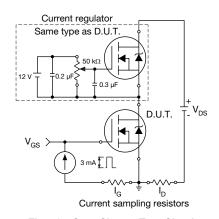


Fig. 18 - Gate Charge Test Circuit

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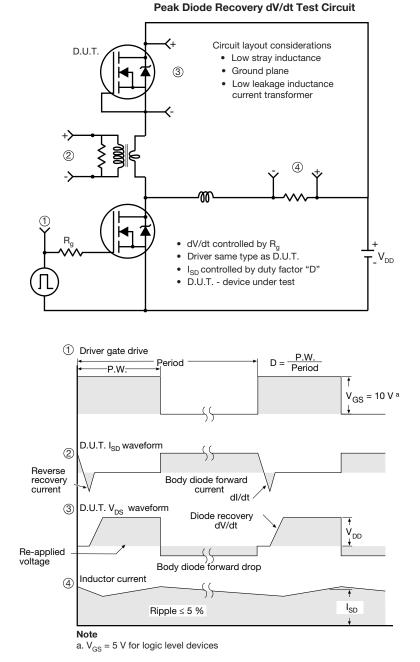


Fig. 19 - For N-Channel

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